

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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EMI Filter with ESD Protection

Features:

- EMI/RFI Bi-directional "Pi" Low-Pass Filters
- ESD Protection Meets IEC61000-4-2
- Diode Capacitance: 7 10 pF
- Zener/Resistor Line Capacitance: 22 ± 20% pF
 Low Zener Diode Leakage: 1 μA Maximum
- Zener Breakdown Voltage; 6 8 Volts
- Pb-Free Package is Available

Benefits:

- Designed to Suppress EMI/RFI Noise in Systems Subjected to Electromagnetic Interference
- Small Package Size Minimizes Parasitic Inductance, Thus a More "Ideal" Low Pass Filtering Response

Applications:

- Cellular Phones
- Communication Systems
- Computers
- Portable Products with Input/Output Conductors

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1) 8 × 20 μs Pulse	P _{PK}	14	W
Maximum Junction Temperature	T_J	150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

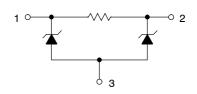
1. All diodes under power



ON Semiconductor®

http://onsemi.com

CIRCUIT DESCRIPTION





SC-75 CASE 463 STYLE 4



X6 M •

X6 = Device Code

M = Date Code*

Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NZF220TT1	SC-75	3000/Tape & Reel
NZF220TT1G	SC-75 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Тур	Max	Unit
Zener Breakdown Voltage, @ I _{ZT} = 1 mA	VZ	6.0	-	8.0	V
Zener Leakage Current, @ V _R = 3 V	I _r	N/A	-	1.0	μΑ
Zener Forward Voltage, @ I _F = 50 mA	V _F	N/A	-	1.25	V
Zener Internal Capacitance, @ 0 V Bias	С	7.0	-	10	pF
Zener/Resistor Array Line Capacitance	С	17.6	-	26.4	pF
Resistance	R	90	-	110	Ω
Cutoff Frequency	F _C (Note 2)	-	220	=	MHz

^{2.} $50~\Omega$ Source and $50~\Omega$ Lead Termination per Figure 2

Applications Information

Suppressing Noise at the Source

- Filter all I/O signals leaving the noisy environment
- Locate I/O driver circuits close to the connector
- Use the longest rise/fall times possible for all digital signals

Reducing Noise at the Receiver

- Filter all I/O signals entering the unit
- Locate the I/O filters as close as possible to the connector

Minimizing Noise Coupling

- Use multilayer PCBs to minimize power and ground inductance
- Keep clock circuits away from the I/O connector
- Ground planes should be used whenever possible
- Minimize the loop area for all high speed signals
- Provide for adequate power decoupling

ESD Protection

- Locate the suppression devices as close to the I/O connector as possible
- Minimize the PCB trace length to the suppression device
- Minimize the PCB trace length for the ground return for the suppression device

Frequency Response Specification

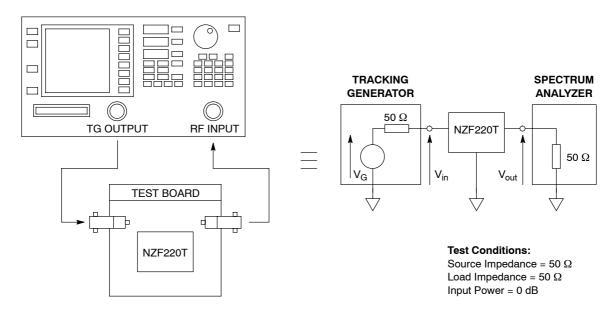


Figure 1. Measurement Conditions

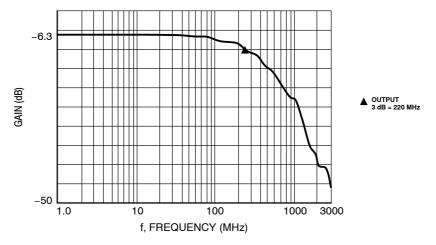
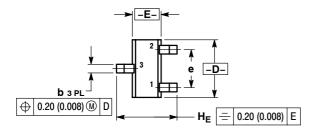
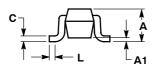


Figure 2. Typical EMI Filter Response (50 Ω Source and 50 Ω Lead Termination)

OUTLINE DIMENSIONS

SC-75/SOT-416 CASE 463-01 ISSUE F





NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
 Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.

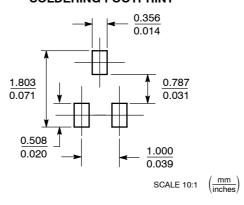
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.70	0.80	0.90	0.027	0.031	0.035
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.15	0.20	0.30	0.006	0.008	0.012
C	0.10	0.15	0.25	0.004	0.006	0.010
D	1.55	1.60	1.65	0.059	0.063	0.067
Е	0.70	0.80	0.90	0.027	0.031	0.035
е	1.00 BSC			0.04 BSC		
L	0.10	0.15	0.20	0.004	0.006	0.008
HE	1.50	1.60	1.70	0.061	0.063	0.065

STYLE 4:

PIN 1. CATHODE 2. CATHODE

2. CATHODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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